



S/N 09/733289

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Xiao-Chun Mu et al.	Examiner:	DiLinh Nguyen
Serial No.:	09/733289	Group Art Unit:	2814
Filed:	December 8, 2000	Docket No:	884.798US1
Title	Microelectronic Package Having an Integrated Heat Sink and Build-Up Layers		
Assignee:	Intel Corporation	Customer No:	21186

PETITION FOR A THREE-MONTH EXTENSION OF TIME

MS AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

In accordance with the provision of 37 CFR § 1.136(a), it is respectfully requested that a three-month extension of time be granted in which to respond to the Final Office Action mailed July 22, 2003, said period of response being extended from October 22, 2003 to January 22, 2004.

Please charge Deposit Account No. 19-0743 in the amount of \$950.00 to cover the required extension fee. Please charge any additional fees or credit overpayment to deposit Account No. 19-0743.

Respectfully Submitted

XIAO-CHUN MU ET AL.

By their Representatives,

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Date: Jan. 22, 2004 By: Ann M. McCrackin
Ann M. McCrackin
Reg. No: 42,858

CERTIFICATE UNDER 37 CFR § 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS AF, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 22nd day of January 2004.

Name: Anne M. Richards

Signature: Anne M. Richards